

Vishay Siliconix

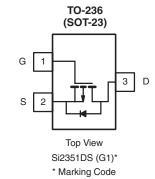
## P-Channel 20-V (D-S) MOSFET

MOSFET PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
- 20	0.115 at V <sub>GS</sub> = - 4.5 V	- 3.0	3.2 nC		
	0.205 at V <sub>GS</sub> = - 2.5 V	- 2.2	3.2 110		

#### FEATURES

- Halogen-free Option Available
- TrenchFET<sup>®</sup> Power MOSFET
- PWM Optimized
- 100 % Rg Tested





Ordering Information: Si2351DS-T1-E3 (Lead (Pb)-free) Si2351DS-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	- 20	V		
Gate-Source Voltage	V <sub>GS</sub>	± 12			
	T <sub>C</sub> = 25 °C		- 2.8		
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C	L	- 2.4		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 2.2 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		- 1.8 <sup>b, c</sup>	A	
Pulsed Drain Current	I <sub>DM</sub>	- 10	-		
	T <sub>C</sub> = 25 °C		- 2.0		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 0.91 <sup>b, c</sup>		
	T <sub>C</sub> = 25 °C		2.1	w	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	1.5		
	T <sub>A</sub> = 25 °C	U	1.0 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		0.7 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range	·	T <sub>J</sub> , T <sub>sta</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, d</sup>	≤5 s	R <sub>thJA</sub>	90	115	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	60 75		0/11	

Notes: a. Based on  $T_C = 25$  °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under Steady State conditions is 130 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		· · · · · · · · · · · · · · · · · · ·					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{DS} = 0 V, I_{D} = -250 \mu A$	- 20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 050 14		- 16.7		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = - 250 μA		2.1			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	- 0.6		- 1.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1		
		$V_{DS}$ = - 20 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			- 10	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \geq$ - 5 V, $V_{GS}$ = - 4.5 V	- 10			Α	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 2.4 A		0.092	0.115		
		V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 1.8 A		0.164	0.205	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 2.4 A		5.5		S	
Dynamic <sup>b</sup>						1	
Input Capacitance	C <sub>iss</sub>			250		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		80			
Reverse Transfer Capacitance	C <sub>rss</sub>			55			
Table Only Observed	Qg	$V_{DS} = -10$ V, $V_{GS} = -5.0$ V, $I_{D} = -2.4$ A		3.4	5.1		
Total Gate Charge				3.2	5	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = -10$ V, $V_{GS} = -4.5$ V, $I_{D} = -2.4$ A		0.5			
Gate-Drain Charge	Q <sub>gd</sub>			1.4			
Gate Resistance	R <sub>g</sub>	f = 1 MHz		8.5	13	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			9	14		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 5.26 $\Omega$		30	45	- ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	${\rm I_D}\cong$ - 1.9 A, ${\rm V_{GEN}}$ = - 4.5 V, ${\rm R_G}$ = 1 $\Omega$		32	48		
Fall Time	t <sub>f</sub>			16	24		
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	ا <sub>S</sub>	T <sub>C</sub> = 25 °C			- 2.0	Α	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				- 10		
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 2.0 A		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			17	26	ns	
Body Diode Reverse Recovery Charge	Diode Beverse Becovery Charge Q			5	8	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = -2.0 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$		14			
/erse Recovery Rise Time t <sub>b</sub>			3		ns		

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

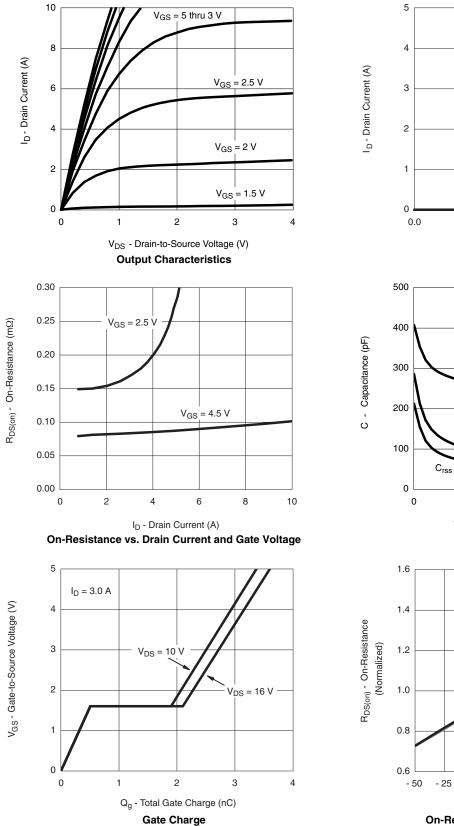
b. Guaranteed by design, not subject to production testing.

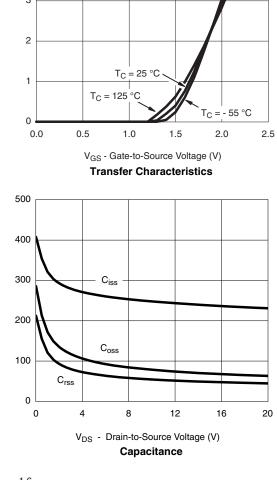
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

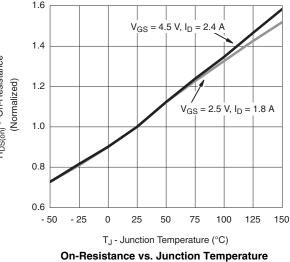


### Si2351DS Vishay Siliconix

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





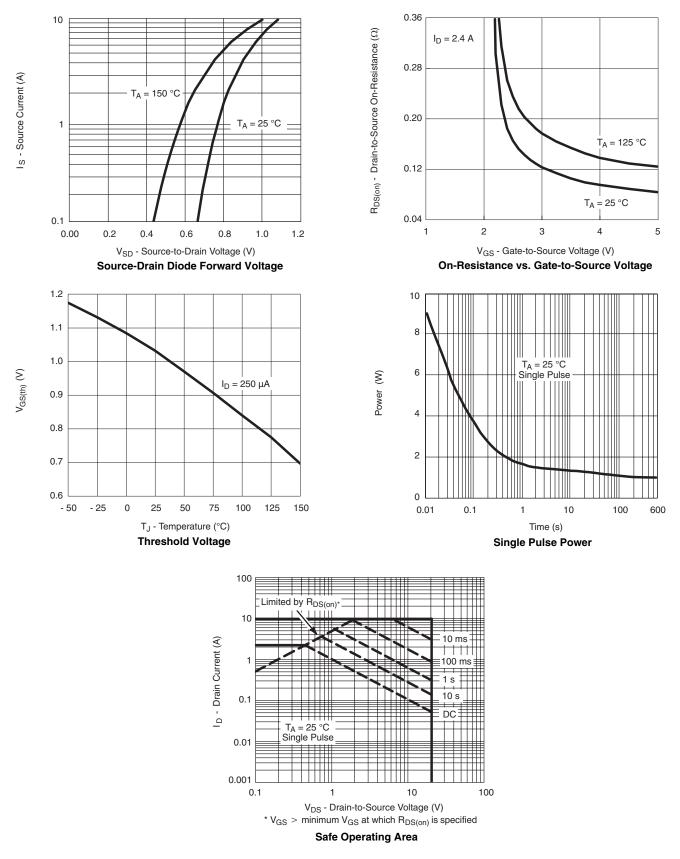


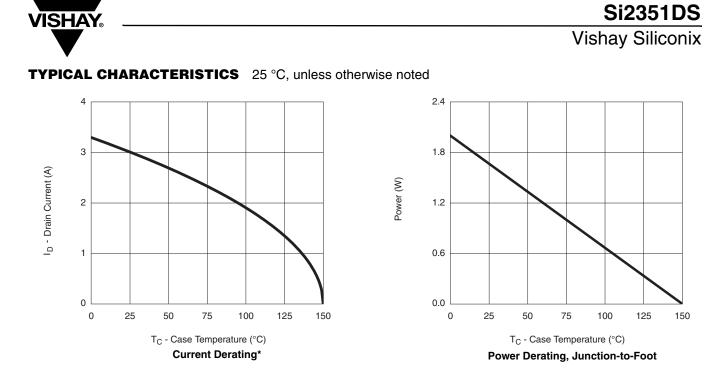
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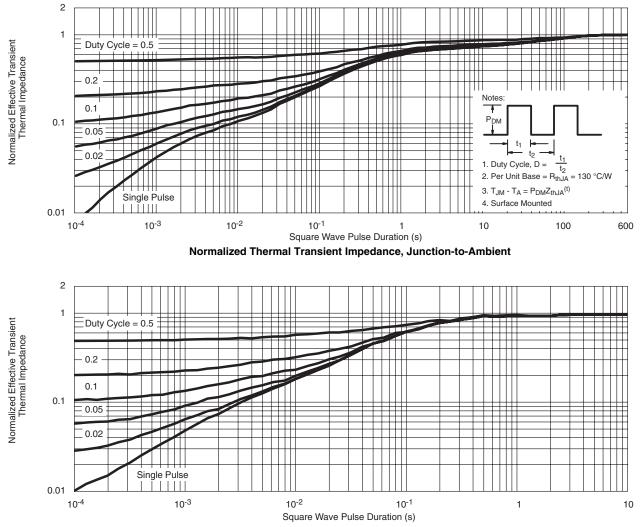




\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?73702



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